

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Chopra et al.

Serial No.: 10/620,002

Filed: July 14, 2003

VIA ELECTRONIC FILING

January 11, 2008

For: SLURRY FOR USE WITH FIXED-
ABRASIVE POLISHING PADS IN
POLISHING SEMICONDUCTOR DEVICE
CONDUCTIVE STRUCTURES THAT
INCLUDE COPPER AND A COPPER
BARRIER (as amended)

Confirmation No.: 7481

Examiner: L. Umez-Eronini

Group Art Unit: 1792

Attorney Docket No.: 2269-4373.2US
(00-0036.02/US)

RESPONSE

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Examiner:

This Response follows the Office Action mailed of October 11, 2007, the shortened statutory period for response to which expires on January 11, 2008.